EPIC Endcap TOF Layout

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Introduction

The goal is to conceive a reference layout and technical design (v0) as inputs to GD/I group to advance the detector integration (service routing etc.)

However, there are still going studies to investigate the optimal pixel granularity based on physics performance so by no means this is a proposal for final design



ETOF Layout



Sensors, ASICs and Service Hybrids

Sensors:

- Each sensor is a matrix of 0.5x0.5 mm² pitch pixels
- In general, larger sensors are preferred to maximize active area but also have to consider yields etc. in fabrication
- Each sensor is assumed to be 32x32 pixels or 1.6x1.6 cm²



ASICs:

• Match the sensor pixelization and size and bump bonded to the sensor

<u>Service Hybrids:</u> situated **on top of sensor+ASICs** provide power and readout services to the modules via flex circuit connectors



Service Hybrids

(CERN chips or

EIC equivalent ones)



- Ip-GBT: low power gigabit transceiver
- VTRx+: optical link module for data transmission
- SCA: control and configuration of FE chips, and enable DC-DCs



ETOF Layout



3 types of modules to tile the full DEE:

For each module:

- 1 fiber to DAQ ٠
- 2 LV cables (1 supply, 1 return)
- 2 BV cables (1 supply, 1 return) •

	Forward	Backward
Sensors/ASICs	4352	2304
LV cables	424	248
HV cables	424	248
Fibers	212	124

Service routing in CMS ETL



ETOF Power budget

	Forward	Backward
Sensors	0.6kW	0.35kW
EPTROC	8.5kW (17kW)	4.8kW (9.6kW)
DC-DC	3.5kW	2kW
lpGBT, VTRx+, SCA	0.5kW	0.3kW
Power cables	0.5kW	0.3kW
Total	13.6kW (22.1kW)	7.75 (12.55kW)

Backups

CMS ETL Layout

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1: Flipped module 2: Readout board 3: Board-to-board connector 4: Connector to powerboard 5: BV connector 6: GBT-SCA 7: lpGBT 8: VTRx+

Readout board - 7-module SH Readout board - 7-module SH - 7-module SH - 7-module SH - 6-module SH - 6-module SH - 6-module SH - 7-module SH - 7-module SH

CMS ETL Layout



